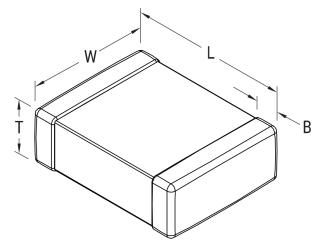


C1206X103J3GACTU

Aliases (C1206X103J3GAC7800)

SMD Comm COG Flex, Ceramic, 0.01 uF, 5%, 25 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1206



Click here for the 3D model.

Dimensions	
Chip Size	1206
L	3.3mm +/-0.4mm
W	1.6mm +/-0.35mm
Т	1mm +/-0.20mm
В	0.6mm +/-0.25mm

Packaging Specifications	ecifications	
Packaging	T&R, 180mm, Plastic Tape	
Packaging Quantity	2500	
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General Information				
Series	SMD Comm COG Flex			
Style	SMD Chip			
Description	SMD, MLCC, FT-CAP, Ultra-Stable			
Features	FT-CAP, Ultra-Stable			
RoHS	Yes			
Termination	Flexible Termination			
Marking	No			
AEC-Q200	No			
Component Weight	25 mg			
Shelf Life	78 Weeks			
MSL	1			

Specifications				
Capacitance	0.01 uF			
Measurement Condition	1 kHz 1.0Vrms			
Capacitance Tolerance	5%			
Voltage DC	25 VDC			
Dielectric Withstanding Voltage	62.5 VDC			
Temperature Range	-55/+125°C			
Temperature Coefficient	COG			
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms			
Dissipation Factor	0.1% 1 kHz 1.0Vrms			
Aging Rate	0% Loss/Decade Hour			
Insulation Resistance	100 GOhms			

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.